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**Lee et al.**

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(54) **LED CHIP**

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(\*) Notice: This patent is subject to a terminal disclaimer.

(\*\*) Term: **14 Years**

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(30) **Foreign Application Priority Data**

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(52) **U.S. Cl.**  
USPC ..... **D13/180**

(58) **Field of Classification Search** ..... D13/180;  
D26/1, 2; 257/79, 80, 81, 88, 89, 95, 98,  
257/99, 100, E33.058; 313/483, 498, 500;  
362/555, 800  
See application file for complete search history.

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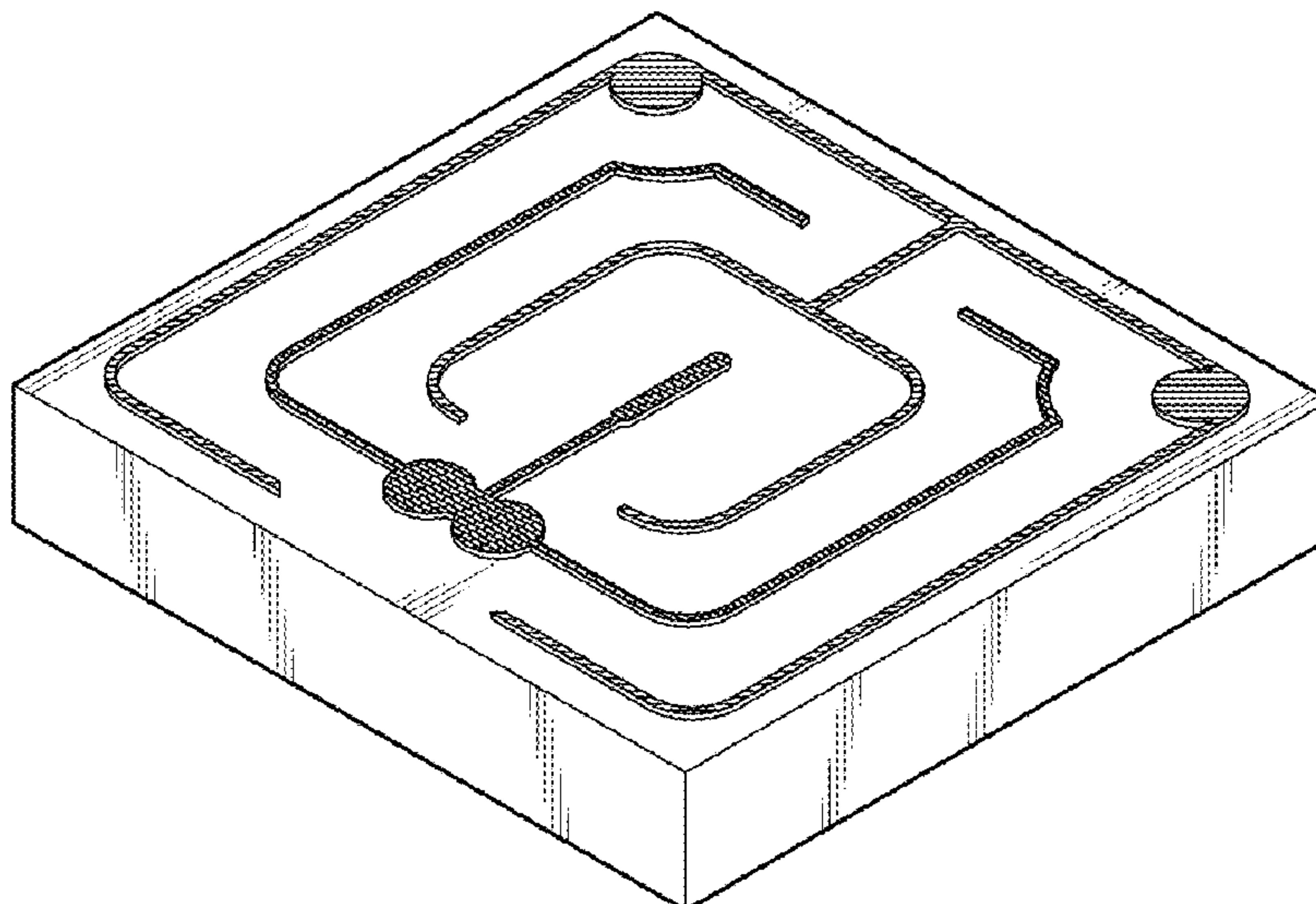
(57) **CLAIM**

The ornamental design for LED chip, as shown and described.

**DESCRIPTION**

FIG. 1 is a front perspective view of LED chip showing the new design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a left side elevational view thereof;  
FIG. 5 is a right side elevational view thereof;  
FIG. 6 is a top plan view thereof; and,  
FIG. 7 is a bottom plan view thereof.

**1 Claim, 7 Drawing Sheets**



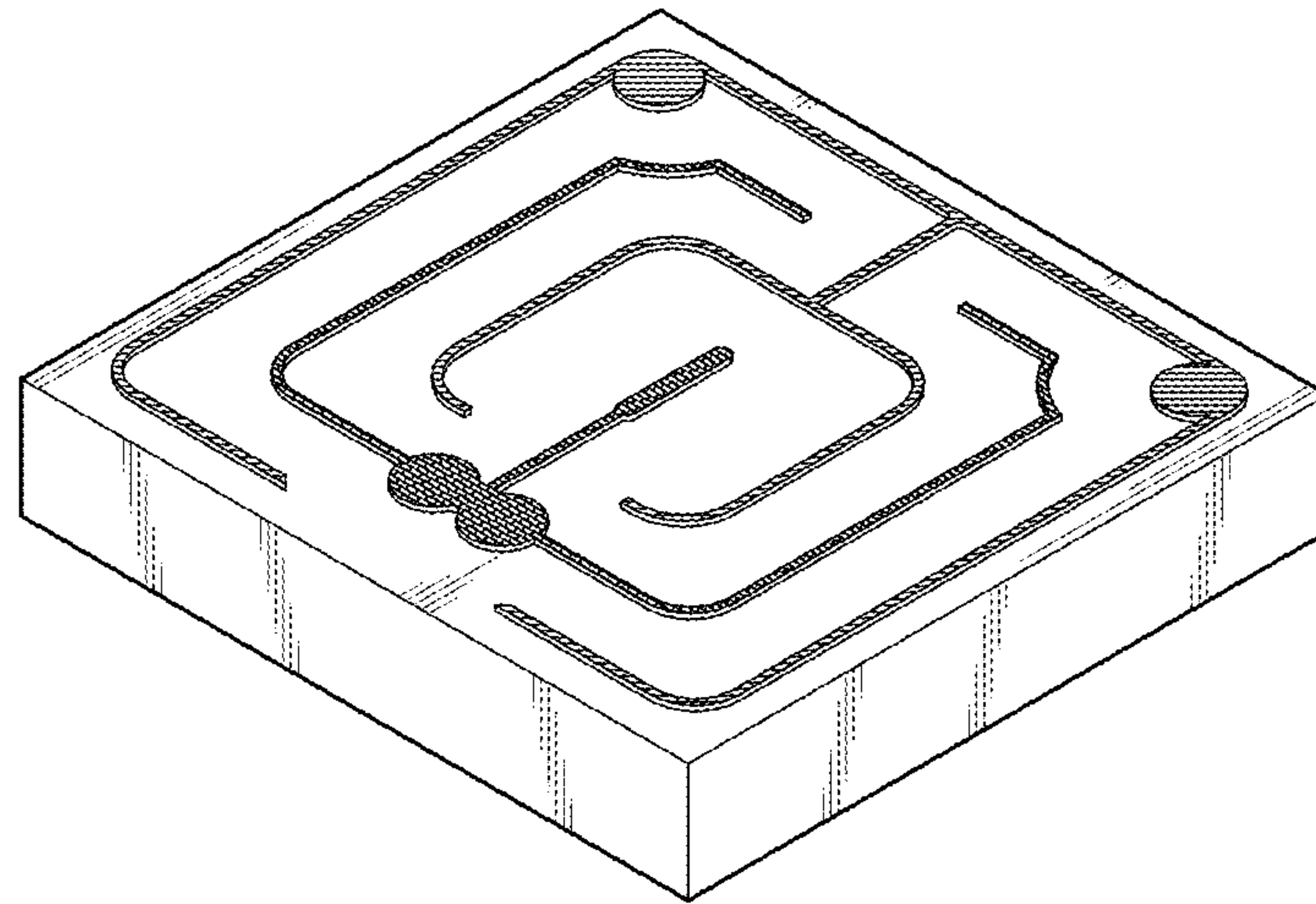
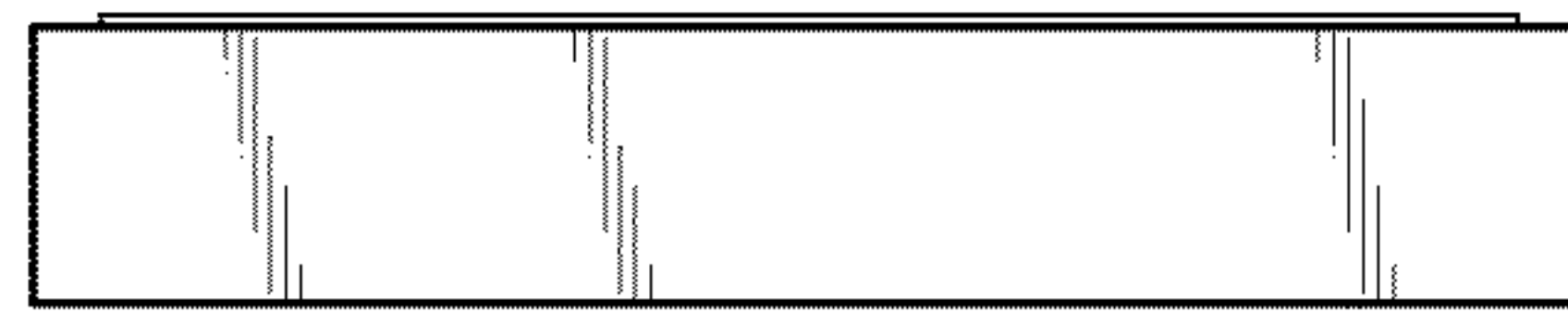


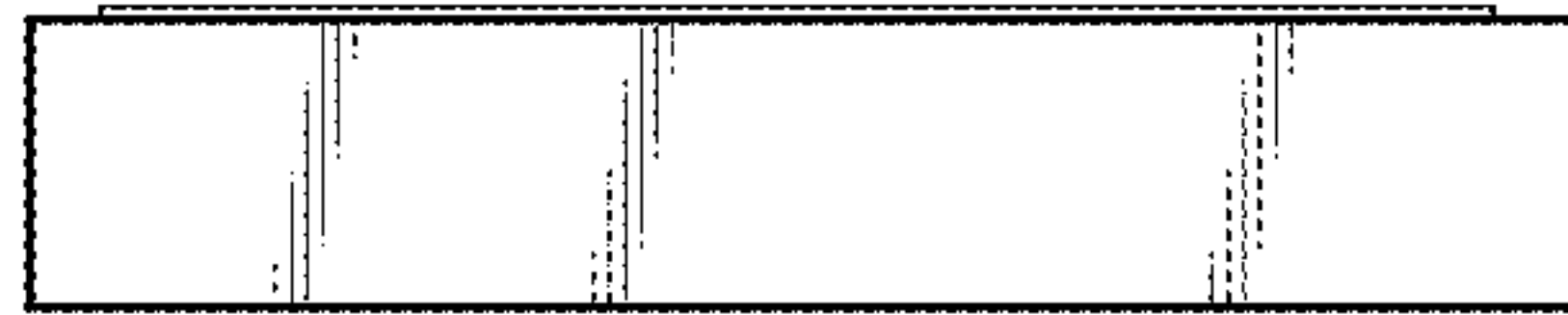
FIG. 1



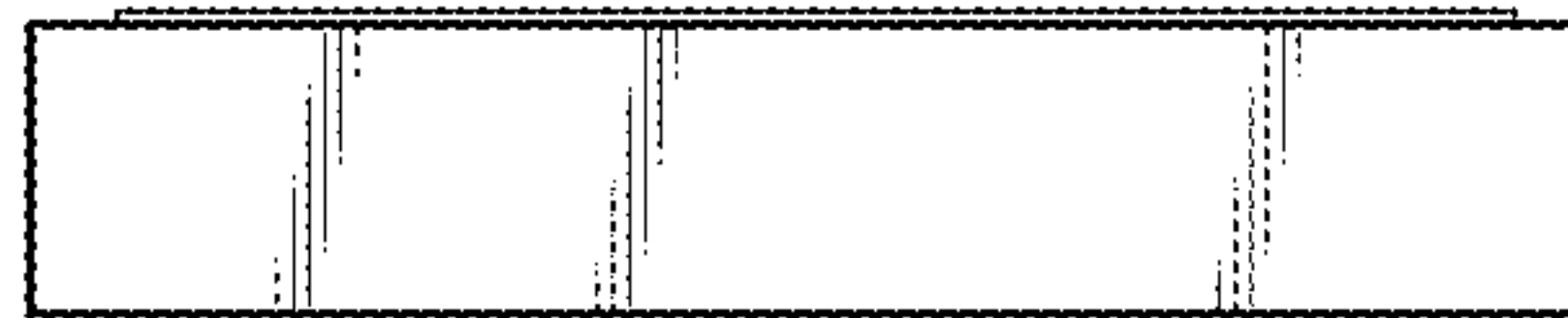
**FIG.2**



**FIG.3**



**FIG.4**



**FIG.5**

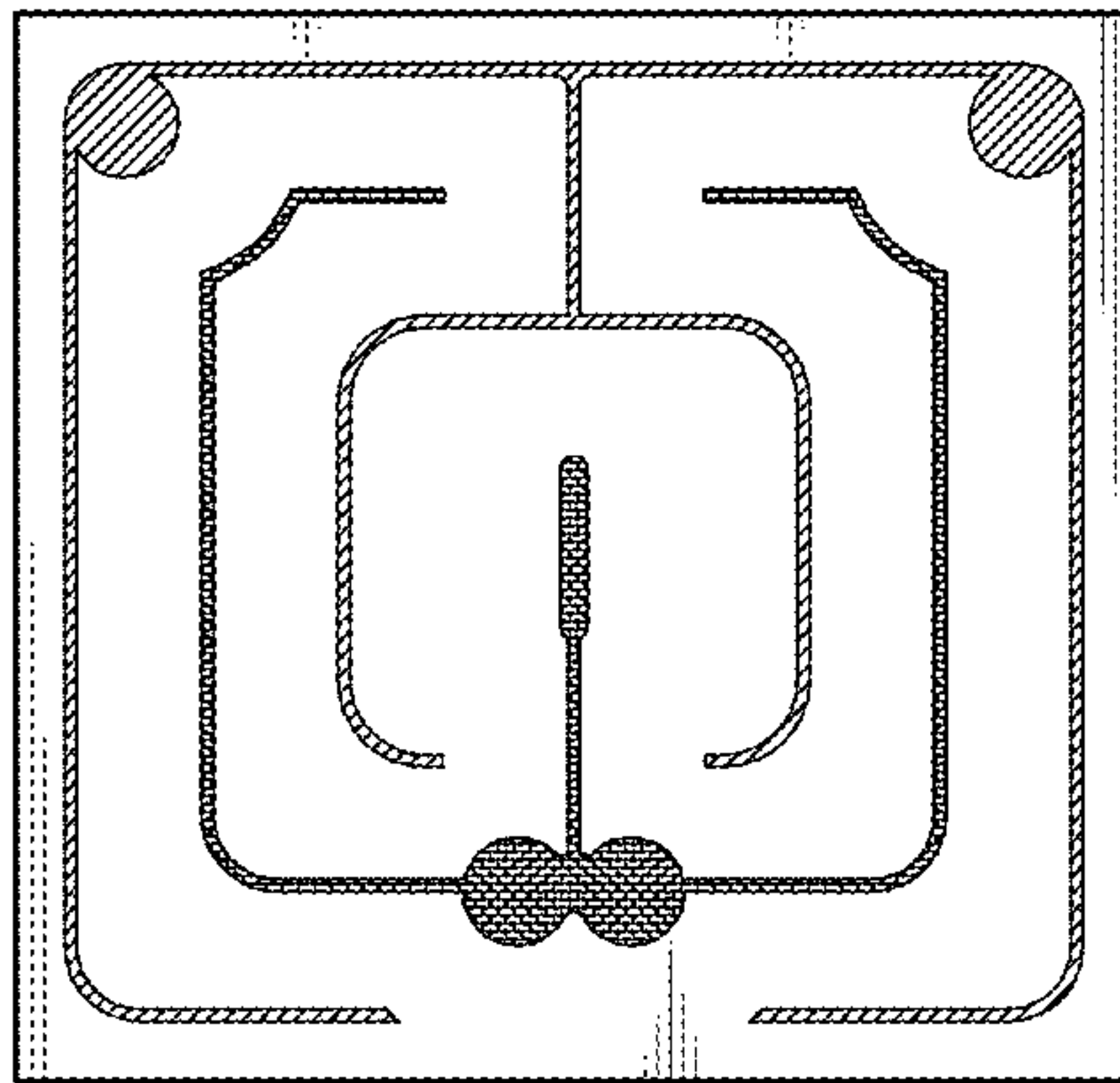
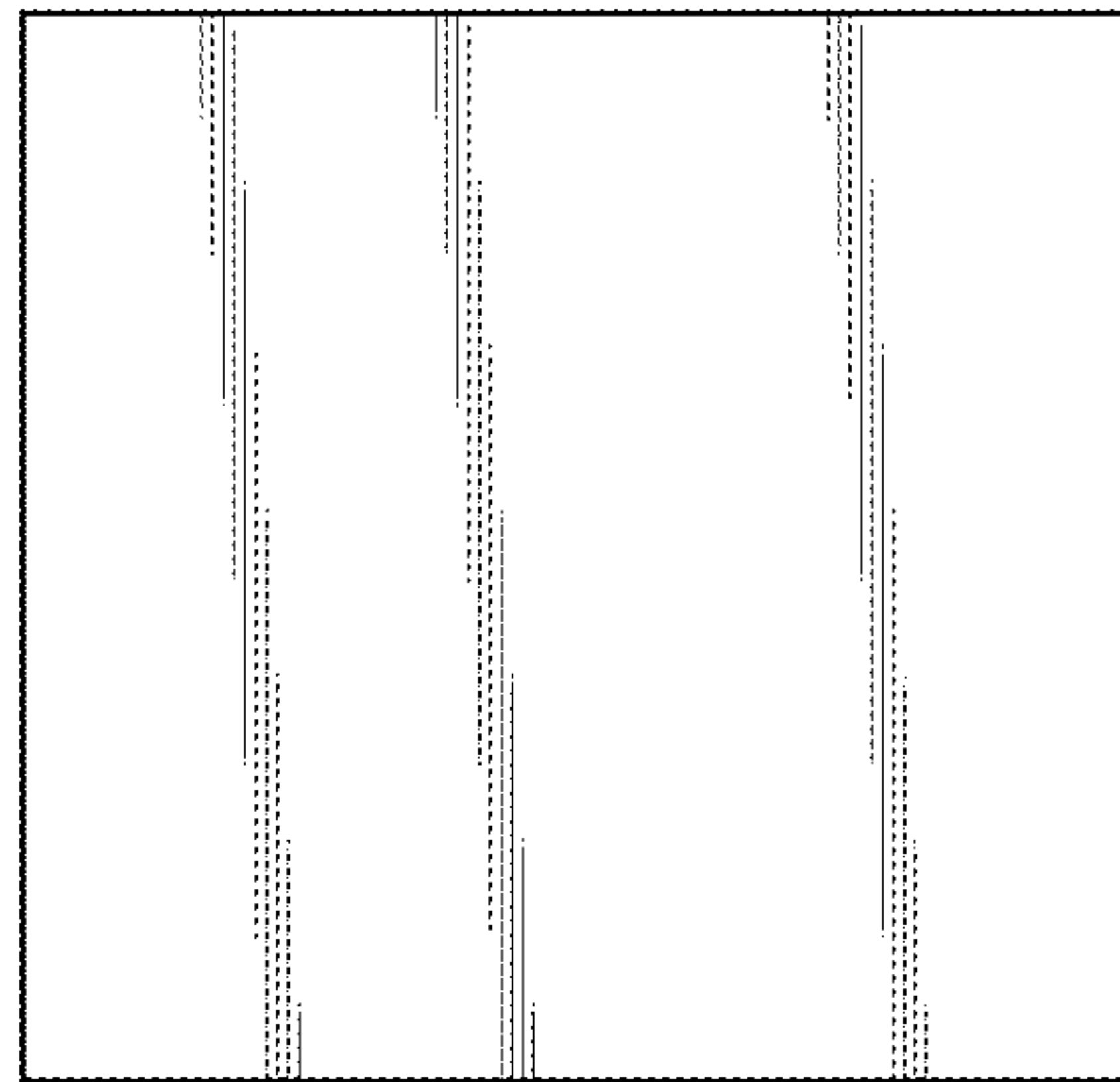


FIG. 6



**FIG.7**